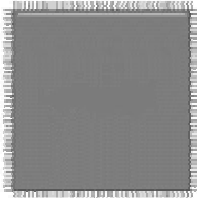
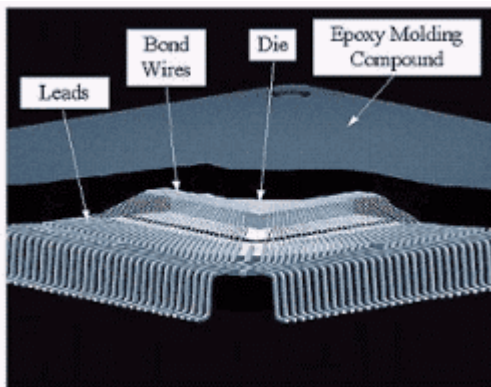




## **SURFACE MOUNT TECHNOLOGY (SMT)**



### **QUAD FLAT PACKAGE**



Surface Mounting Technology (SMT) using quad flat packages on printed circuit boards was the most popular in the early years of the liquid crystal display industry, and is still available for mass production.

Plastic Quad Flat Package (QFP) represents itself as a flat rectangular integrated circuit package with its leads projecting from all four sides of the package without radius. Used with surface mounting method. Made of black epoxy resin. Very moisture absorbent.

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